

The background of the slide features the official logo of the Indian Institute of Technology Bombay. It consists of a large gear-like outer circle. Inside this circle is a lotus flower. The text "INDIAN INSTITUTE OF TECHNOLOGY BOMBAY" is written in English along the top inner edge of the gear. In the center, above the lotus, is the Sanskrit motto "संस्थान मुंबई". Below the lotus, another Sanskrit motto "ज्ञानम् परमम् ध्येयम्" is written on a banner.

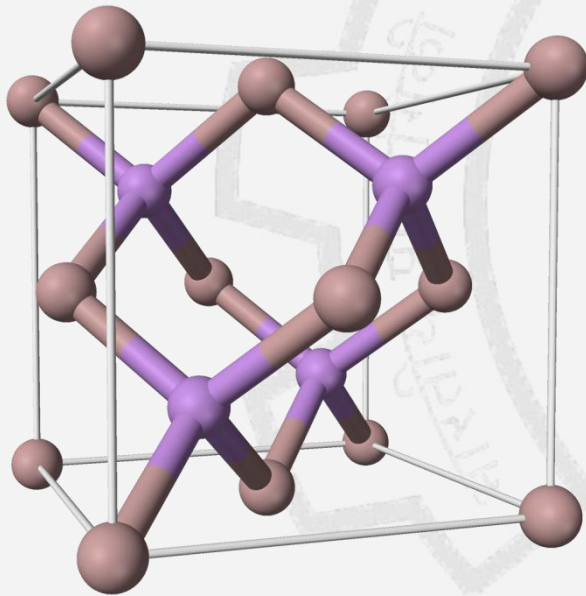
# *EE669: VLSI Technology*

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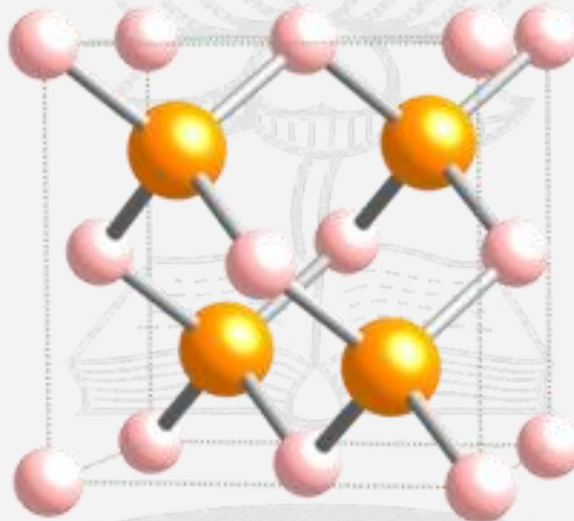
**Email: [laha@ee.iitb.ac.in](mailto:laha@ee.iitb.ac.in), Tel: 022 25769408**

**Office hour: Friday 10:00 – 11.00 AM, EE Annex, Room: 104**

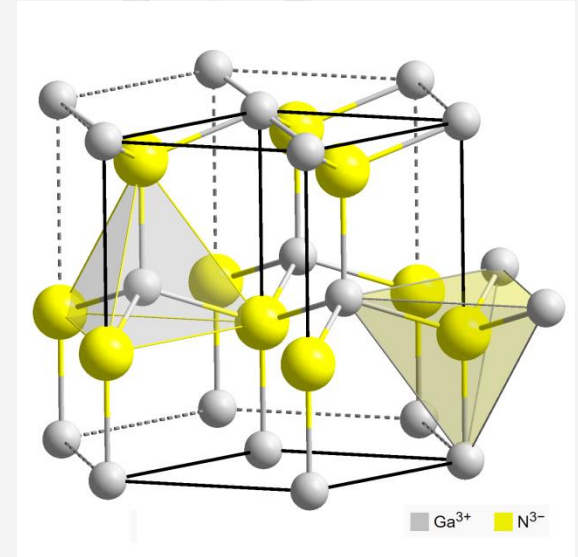
# Power of III-V (compound) semiconductor



GaAs



InP



GaN

# Some astonishing numbers

## Population by Rural Urban Residence – India - 2011

Persons:

- Total : 1,210,193,422
- Rural: 833,087,662
- Urban: 377,105,760

Rural Urban Distribution  
Persons (in %):

- Total : 100.0 %
- Rural: 68.84 %
- Urban: 31.16 %

- **Approximate number electronic gadgets  
1.6 billion**

Each gadget wastes approx. 5 watts of power  
per day at the adaptor (during conversion)

- ❑ **Total waste per day: 8 Giga watt**

- ❑ **Total waste per year: ~3 T Watt ONLY  
due to power conversion in electronic  
gadgets**

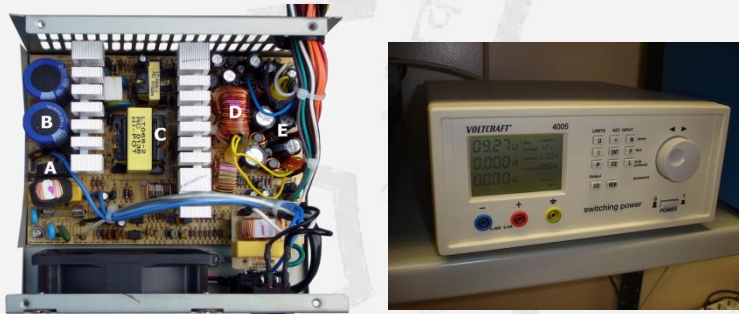


!!!!!!!

# How are we going to address this serious issue



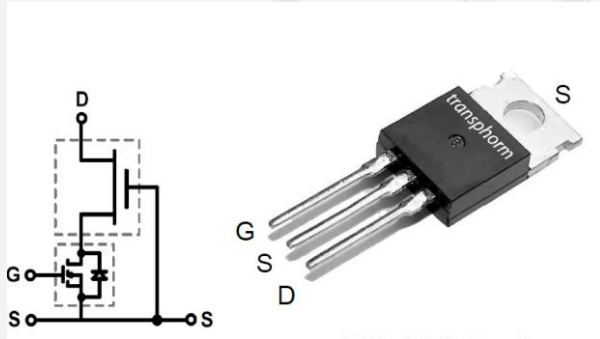
Average efficiency 40–50%



Switch Mode Power Supply



Efficiency: 80-90%



Efficiency > 95%

GaN based power converter

About **32 billion kilowatt-hours (kWh)** per year, could be saved in the United States by replacing all linear power supplies. Source: Wikipedia

# Differences between MOSFETs and HEMTs

## HEMTs

- Operate in the microwave range (300MHz-300GHz)
- Heterojunction is used as the channel

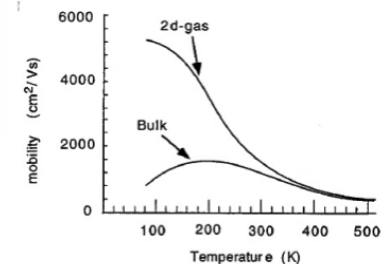
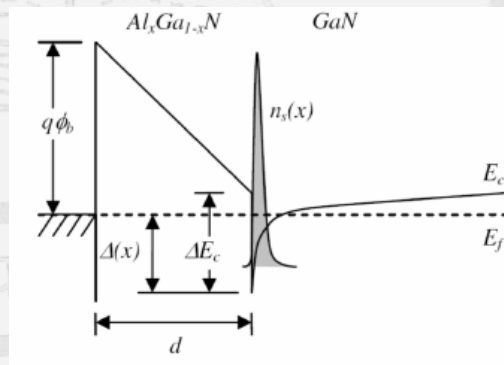
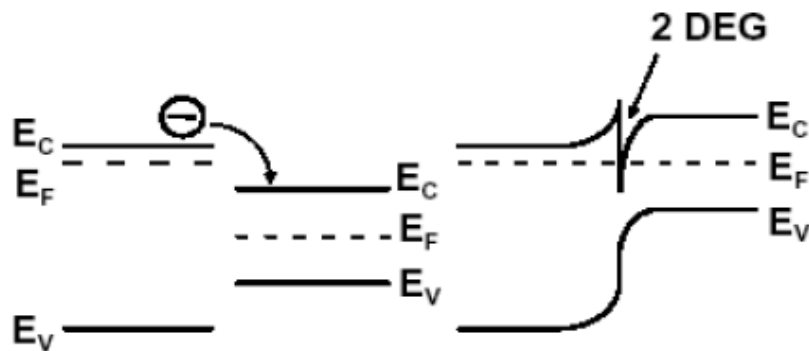
## MOSFETs

- Operation in the UHF range (300MHz-3GHz)
- Doped region is used as the channel



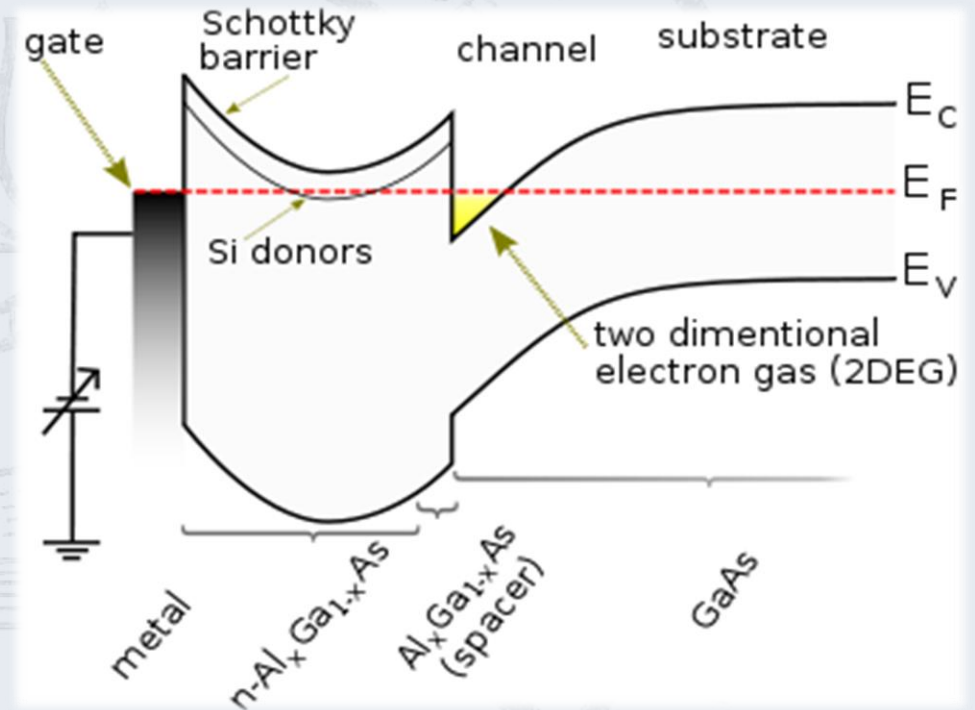
# Operation principles (2 DEG)

- Discontinuity through the conduction band of the two semiconductors determines a charge transfer, creating a triangular potential.
- Electrons are confined in the triangular potential in discrete quantum state.
- Mobility of the electrons in 2DEG is higher than in a bulk.



# How do HEMTs work?

- HEMT's take advantage of 2DEG which is created at the AlGaAs/GaAs heterojunction.
- The 2DEG is confined at the heterojunction and free to move parallel to the channel.
- This results in a higher electron mobility
- Good for large gain and high frequency characteristics.



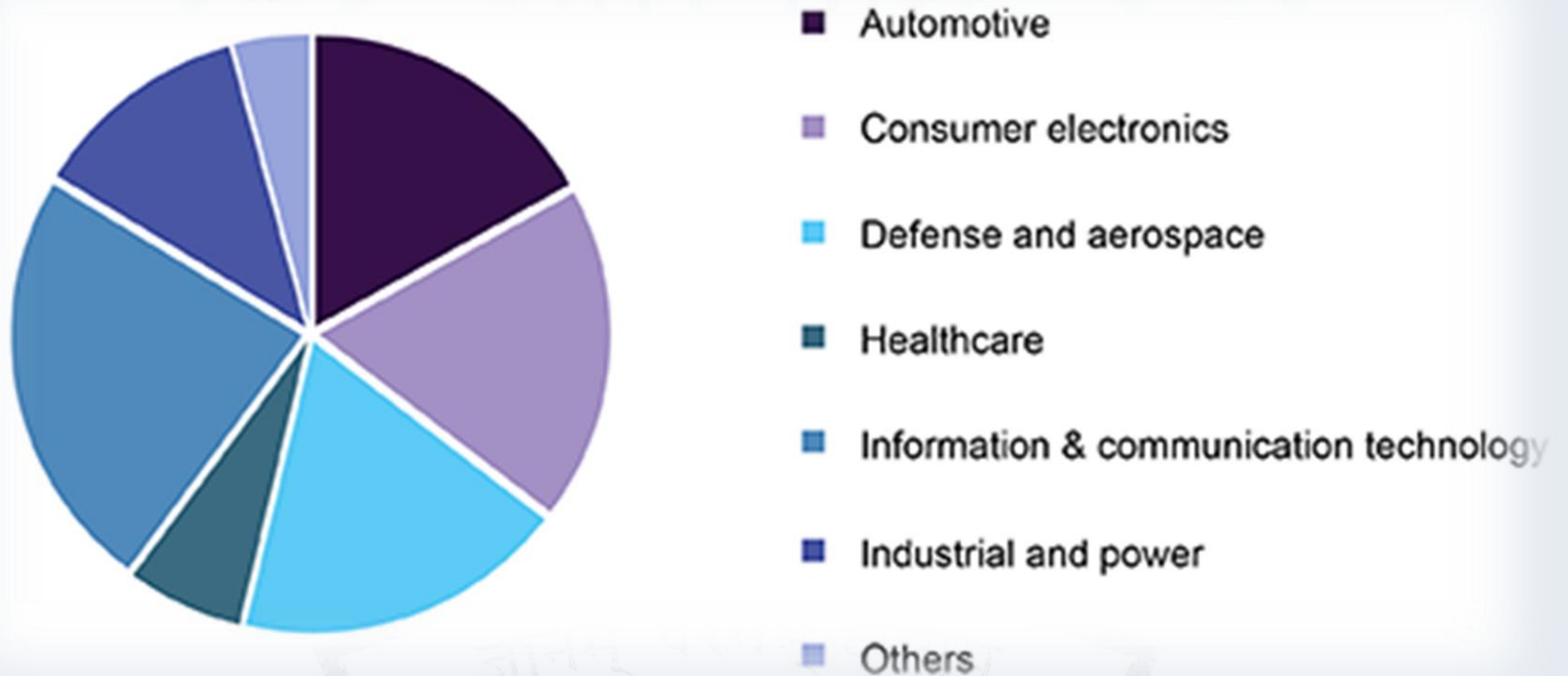
Energy band diagram for AlGaAs/GaAs heterojunction at thermal equilibrium

**You don't even require the doping in GaN based heterostructure!!!**





# Asia Pacific GaN semiconductor device market by application



# Solid state lighting





Nobelpriset i fysik 2014

The Nobel Prize in Physics 2014

# Nobelpriset i fysik 2014

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# Outline

- Why III-Nitride semiconductor??
- AlGa<sub>N</sub>/Ga<sub>N</sub> heterostructure: Advantages and Disadvantages
- Issues with growth of epitaxial layers
- MBE growth of Ga<sub>N</sub>, AlGa<sub>N</sub>/Ga<sub>N</sub> heterostructure on various substrates
- Nanowires: Promising solution to circumvent the challenges in heterostructure growth
- New horizon yet to be explored
- Summary

# Materials Properties Comparison

| Material | $\mu$ | $\epsilon$ | $E_g$ | BFOM Ratio | JFM Ratio | Tmax  |
|----------|-------|------------|-------|------------|-----------|-------|
| Si       | 1300  | 11.4       | 1.1   | 1.0        | 1.0       | 300 C |
| GaAs     | 5000  | 13.1       | 1.4   | 9.6        | 3.5       | 300 C |
| SiC      | 260   | 9.7        | 2.9   | 3.1        | 60        | 600 C |
| GaN      | 1500  | 9.5        | 3.4   | 24.6       | 80        | 700 C |

BFOM = Baliga's figure of merit for power transistor performance [ $K \cdot \mu \cdot E_g^3$ ]

JFM = Johnson's figure of merit for power transistor performance

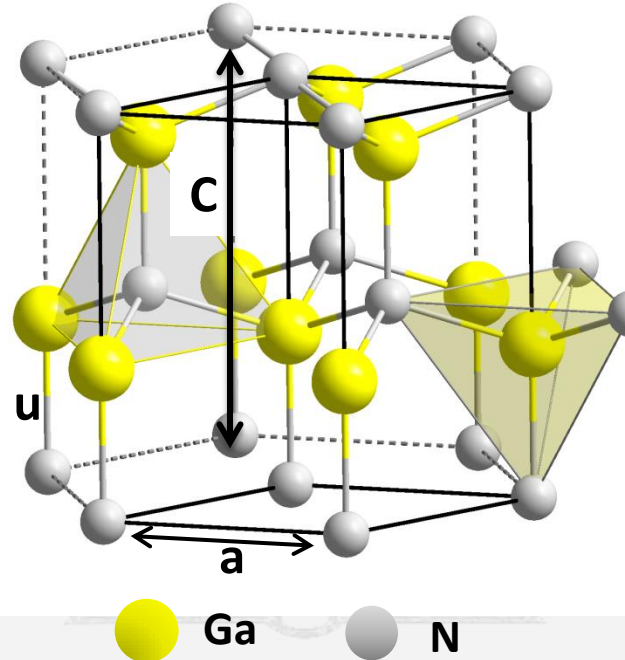
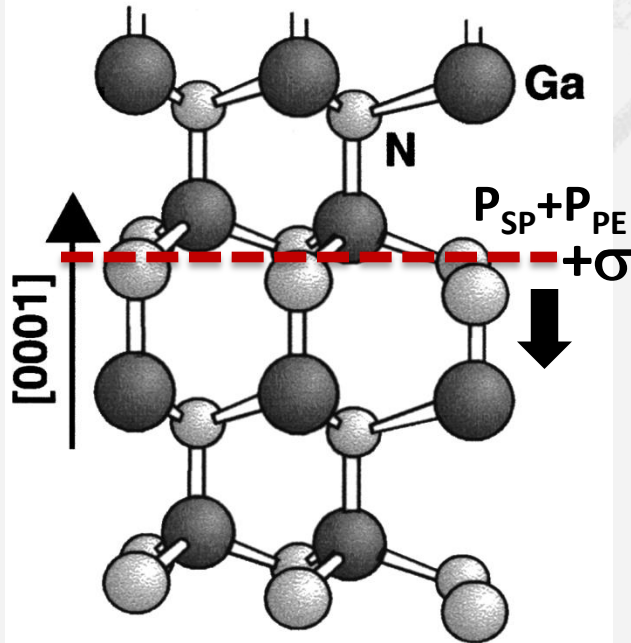
(Breakdown, saturation electron velocity product) [ $E_{br} \cdot V_{sat} / 2\pi$ ]

Source: UCSB



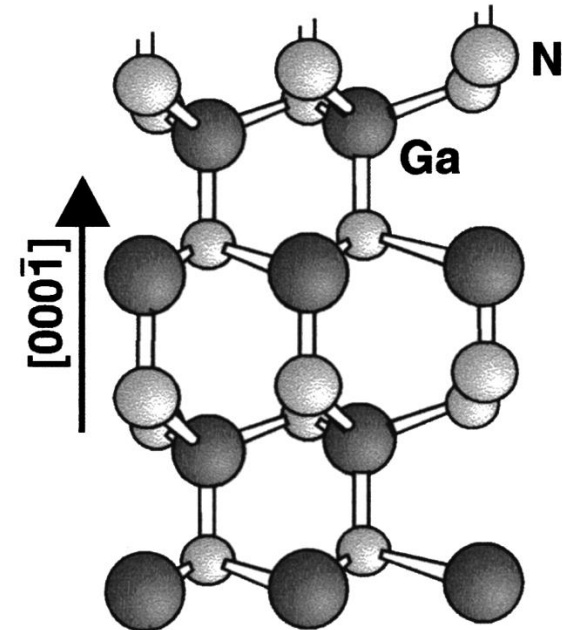
# Structure of GaN

Ga-face



Wurtzite

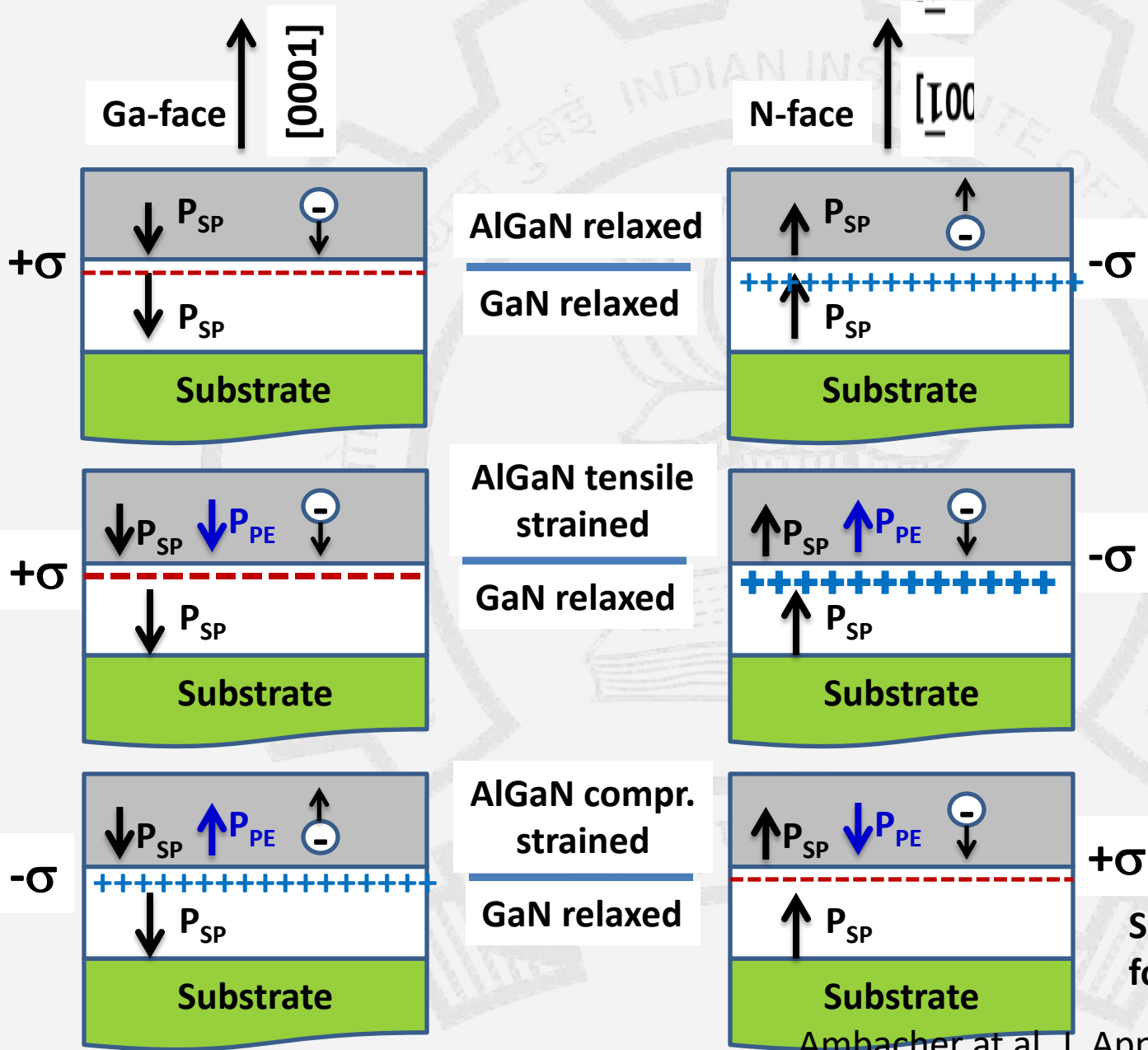
N-face



Substrate

The  $(0001)$  and  $(000\bar{1})$  surfaces of GaN are **nonequivalent** and differ in their chemical and physical properties. Crystallographic polarity along these axes results spontaneous polarization.

# Polarization in GaN/AlGaN heterostructure



$$P_{SP} = P_{SP}z$$

$$P = P_{SP} + P_{PE}$$

$$P_{PE}$$

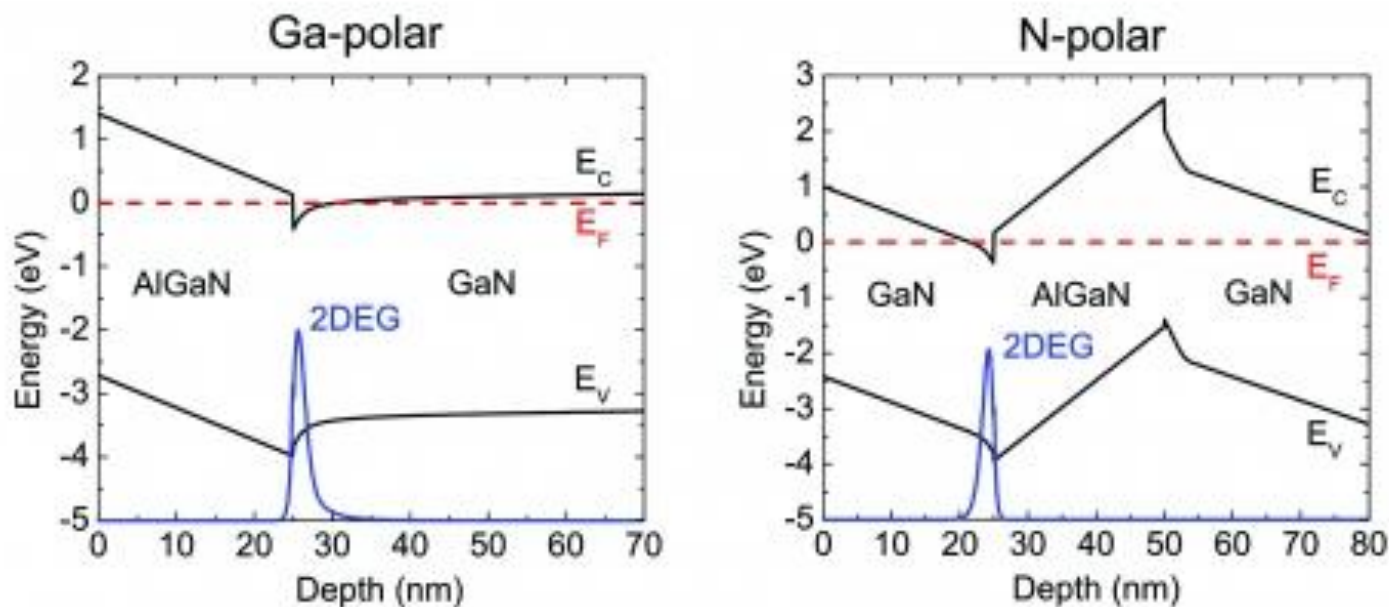
$$2 \frac{a - a_0}{a_0} \left( e_{31} - e_{33} \frac{C_{13}}{C_{33}} \right)$$

$$\left( e_{31} - e_{33} \frac{C_{13}}{C_{33}} \right) < 0$$

for AlGaN over the whole range of compositions

Spontaneous polarization for GaN and AlN < 0

# Looking at band structure of AlGaN/GaN HEMT

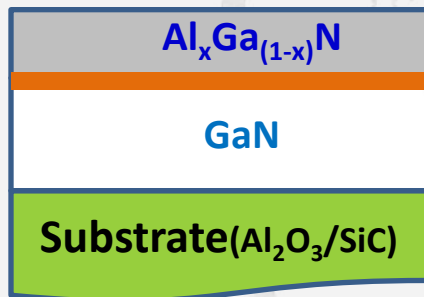


- Discontinuity at the conduction band of the two semiconductors determines a charge transfer, creating a triangular potential.
- Electrons are confined in the triangular potential in discrete quantum state.
- Mobility of the electrons in 2DEG is higher than in a bulk.

# Heart of HEMT: 2DEG

For high power, high frequency HEMTs based on  $\text{Al}_x\text{Ga}_{(1-x)}\text{N}/\text{GaN}$ :

- high  $x_{\text{Al}}$ ,
- coherently strained,
- trap free **AlGaN/GaN heterojunction**,
- (abrupt + smooth on an atomic level)



2DEG  
(density and mobility)

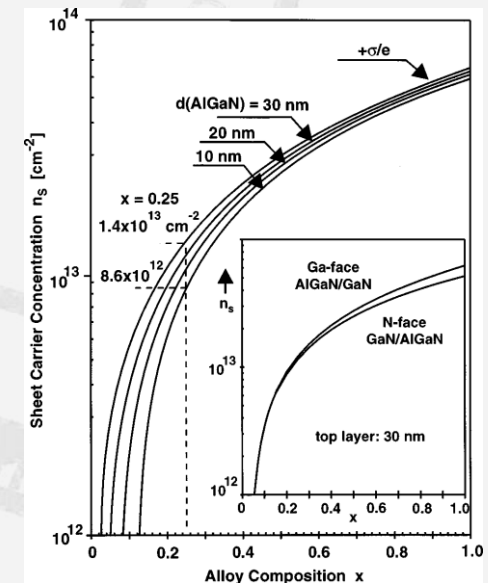
- ✓ *carrier confinement,*
- ✓ *high breakdown voltage,*
- ✓ *high currents*

Determined by

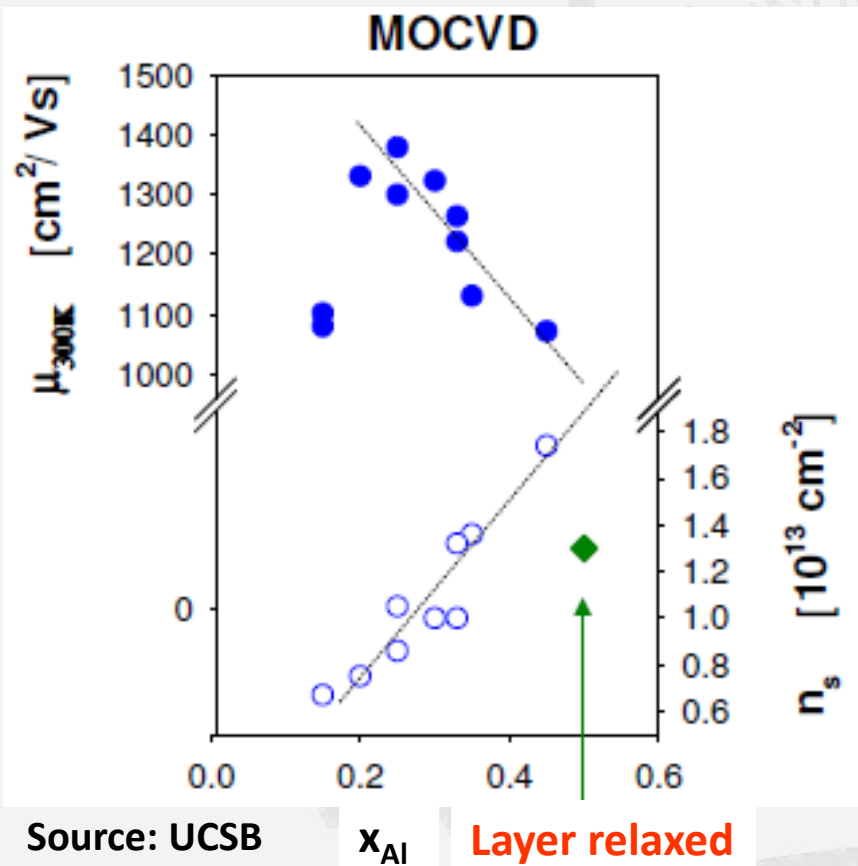
- $x_{\text{Al}}$
- interface roughness
- alloy scattering
- dislocation, etc.

Sheet carrier concentration of the 2DEG confined at a Ga-face  $\text{GaN}/\text{AlGaN}/\text{GaN}$  interface for different thickness of the AlGaN barrier.

Ambacher et al. J. App. Phys. 85, 3222 (1999)



# 2DEG: Influence of the Al-composition



For  $x_{Al} > 0.2$ :  $\mu_{300} \sim 1/x_{Al}$

$x_{Al} \uparrow$  { interface problems  
- strain induced defects  
- higher impurity incorporation  
- alloy ordering/clustering

$n_s \sim x_{Al}$  { charge increases due to  
spontaneous polarization  
and piezoelectric effects

For  $x_{Al} < 0.2$ :  $\mu_{300} \sim x_{Al}$

AlGaN/GaN HEMTs transistor don't need doping to obtain a high electron density.

- ✓ better confinement of the 2DEG at higher  $x_{Al}$
- ✓ low  $x_{Al}$  = low  $n_s$ : less efficient screening of defects

Optimum Al conc. 25-30%